SN54ALS273, SN74ALS273 OCTAL D-TYPE FLIP-FLOPS WITH CLEAR

SDAS218A - APRIL 1982 - REVISED DECEMBER 1994

- Contain Eight Flip-Flops With Single-Rail Outputs
- Buffered Clock and Direct-Clear Inputs
- Individual Data Input to Each Flip-Flop
- Applications Include:

Buffer/Storage Registers Shift Registers

Pattern Generators

 Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

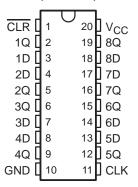
description

These octal positive-edge-triggered flip-flops utilize TTL circuitry to implement D-type flip-flop logic with a direct-clear (CLR) input.

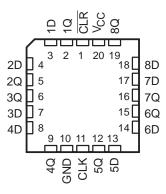
Information at the data (D) inputs meeting the setup-time requirements is transferred to the Q outputs on the positive-going edge of the clock (CLK) pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When CLK is at either the high or low level, the D input signal has no effect at the output.

The SN54ALS273 is characterized for operation over the full military temperature range of -55° C to 125°C. The SN74ALS273 is characterized for operation from 0°C to 70°C.

SN54ALS273 . . . J PACKAGE SN74ALS273 . . . DW OR N PACKAGE (TOP VIEW)



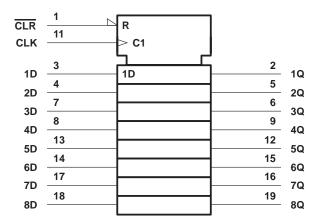
SN54ALS273 . . . FK PACKAGE (TOP VIEW)



FUNCTION TABLE (each flip-flop)

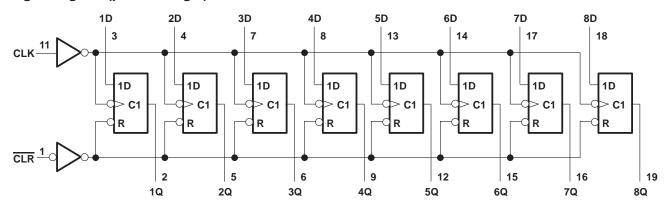
	INPUTS	OUTPUT	
CLR	CLK	D	Q
L	Х	Х	L
Н	\uparrow	Н	Н
Н	\uparrow	L	L
Н	H or L	Χ	Q ₀

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V _{CC}	7 V
Input voltage, V _I	7 V
Operating free-air temperature range, T _A : SN54ALS273	–55°C to 125°C
SN74ALS273	0°C to 70°C
Storage temperature range	65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



recommended operating conditions

			SN	SN54ALS273		SN74ALS273			LIMIT	
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
VCC	Supply voltage		4.5	5	5.5	4.5	5	5.5	V	
VIH	High-level input voltage		2			2			V	
V _{IL}	Low-level input voltage				0.7			0.8	V	
ЮН	High-level output current				-1			-2.6	mA	
l _{OL}	Low-level output current				12			24	mA	
fclock	Clock frequency		0		30	0		35	MHz	
		CLR low	10			10				
t _W Pulse duration	Pulse duration	CLK high	16.5			14			ns	
		CLK low	16.5			14				
t _{SU} Setup time before CLK↑	0.1	Data	10			10				
	Setup time before CLK	CLR inactive state	15			15			ns	
t _h	Hold time, data after CLK↑		0			0			ns	
T _A	Operating free-air temperature		-55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN	SN54ALS273			SN74ALS273			
			MIN	TYP [†]	MAX	MIN	TYP [†]	MAX	UNIT	
VIK	V _{CC} = 4.5 V,	I _I = -18 mA			-1.5			-1.5	V	
Voн	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2	2		V _{CC} -2				
	V _{CC} = 4.5 V	I _{OH} = -1 mA	2.4	3.3					V	
	VCC = 4.5 V	$I_{OH} = -2.6 \text{ mA}$				2.4	3.2			
M -	V _{CC} = 4.5 V	I _{OL} = 12 mA		0.25	0.4		0.25	0.4	V	
VOL		I _{OL} = 24 mA					0.35	0.5		
lį	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA	
lін	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μΑ	
I _{IL}	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.2			-0.2	mA	
I _O ‡	V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA	
ICCH	V _{CC} = 5.5 V			11	20		11	20	mA	
ICCL	V _{CC} = 5.5 V			19	29		19	29	mA	

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, los.

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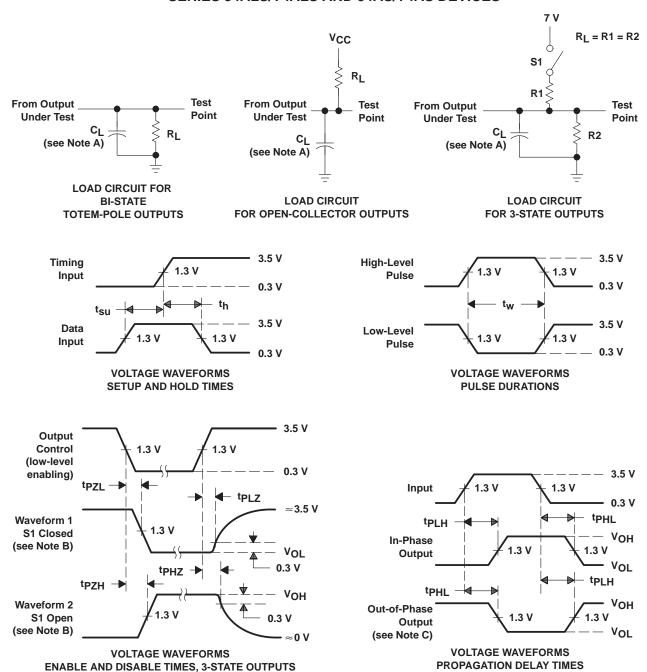
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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R_L = 500 Ω , T_A = MIN to MAX [†]				UNIT
		•	SN54ALS273		SN74ALS273		
			MIN	MAX	MIN	MAX	
f _{max}			30		35		MHz
t _{PHL}	CLR	Any Q	4	24	4	18	ns
t _{PLH}	CLK	Any Q	2	20	2	12	ns
^t PHL	OLK	Ally Q	3	17	3	15	113

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, $t_{\Gamma} = t_{f} = 2$ ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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